

taoglas

DSGP. 18.2.A

Datasheet

### DSGP.1575.18.2.A.02

#### **Description:**

GPS L1 / GALILEO E1 1575.42MHz 18\*18\*2mm Ceramic Patch SMD

#### Features:

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| 1.  | Introduction                        | 3  |
|-----|-------------------------------------|----|
| 2.  | Specifications                      | 4  |
| 3.  | Antenna Characteristics             | 6  |
| 4.  | Radiation Patterns                  | 8  |
| 5.  | Mechanical Drawing                  | 10 |
| 6.  | Antenna Integration Guide           | 11 |
| 7.  | Evaluation Board Mechanical Drawing | 16 |
| 8.  | PCB Footprint Recommendation        | 17 |
| 9.  | Recommended Solder Reflow           | 20 |
| 10. | Packaging                           | 21 |
|     | Changelog                           | 22 |
|     |                                     |    |

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## 1. Introduction



The DSGP.1575.18.2.A.02 is a ceramic GPS L1 / GALILEO E1 passive patch antenna, 18mm square, with a low profile of 2mm thickness. It is designed for applications in space constrained navigation devices, vehicle tracking/fleet management systems, as well as telematics devices.

The antenna has been tuned on a 50 x 50 mm ground plane, working at 1575.42MHz with a 2.4 dBi gain. The ceramic patch is mounted via SMT process, ideal for high volume low cost assembly. It is manufactured and tested in a TS16949 first tier automotive approved facility.

For further optimization to customer specific device environments where ground-plane size is different, custom tuned patch antennas can be supplied. For more details please contact your regional Taoglas sales office.



## Specifications

|          |                               | GNSS                      | Frequency l      | Bands Cover        | ed               |               |                  |
|----------|-------------------------------|---------------------------|------------------|--------------------|------------------|---------------|------------------|
| GPS/QZSS | L1<br>1575.42MHz              | L2<br>1227.6MHz           | L5<br>1176.45MHz | L6<br>1278.75MHz   |                  |               |                  |
|          | $\checkmark$                  |                           |                  |                    |                  |               |                  |
| GLONASS  | L5R<br>1176.45MHz             | L3PT<br>1201.5MHz         | L2PT<br>1246MHz  | L1CR<br>1575.42MHz | L1PT<br>1602MHz  |               |                  |
|          |                               |                           |                  |                    |                  |               |                  |
| Galileo  | E5a<br>1176.45MHz             | E5b<br>1201.5MHz          | E4<br>1215MHz    | E3<br>1256MHz      | E6<br>1278.75MHz | E2<br>1561MHz | L1<br>1575.42MHz |
|          |                               |                           |                  |                    |                  |               |                  |
| BeiDou   | B1<br>1561MHz                 | B2<br>1207.14MHz          | B3<br>1268.52MHz |                    |                  |               |                  |
|          |                               |                           |                  |                    |                  |               |                  |
| Compass  | E5B(B2)/ E6(B3)<br>1268.56MHz | E2(B1)<br>1561MHz         |                  |                    |                  |               |                  |
|          |                               |                           |                  |                    |                  |               |                  |
| SBAS     | Omnistar<br>1542.5MHz         | WAAS/EGN OS<br>1575.42MHz |                  |                    |                  |               |                  |
|          |                               |                           |                  |                    |                  |               |                  |

2.

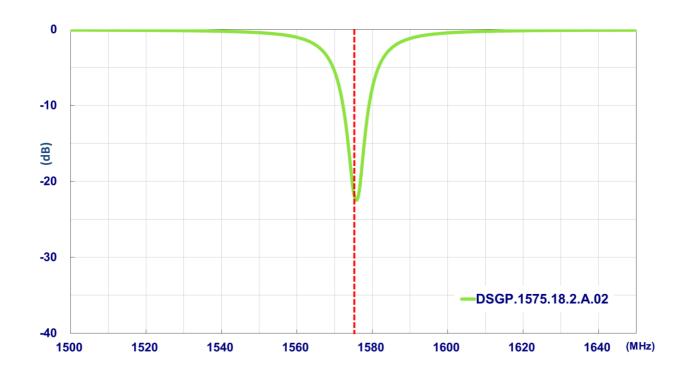


|                                      | Electrical                 |
|--------------------------------------|----------------------------|
| Frequency (MHz)                      | 1575.42                    |
| VSWR (max.)                          | 2.0:1                      |
| Passive Antenna Efficiency (%)       | 55.94                      |
| Passive Antenna Gain at Zenith (dBi) | 2.4                        |
| Return Loss (dB)                     | <-10                       |
| Impedance                            | 50Ω                        |
|                                      | Mechanical                 |
| Height                               | 255 ± 5 mm                 |
| Base Diameter                        | 16.05 ± 0.2 mm             |
| Whip Diameter                        | 4 ± 0.2 mm                 |
| Casing                               | ABS                        |
| Connector                            | TNC Male                   |
|                                      | Environmental              |
| Temperature Range                    | -40°C to 85°C              |
| Humidity                             | Non-condensing 65°C 95% RH |
| Moisture Sensitivity Level (MSL)     | 3 (168 Hours)              |

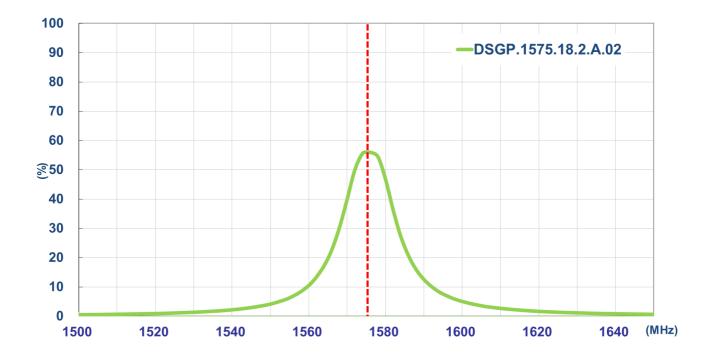






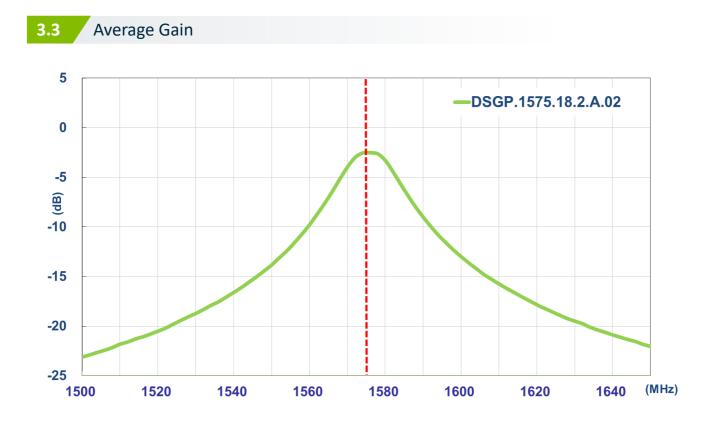


**3.2** Efficiency



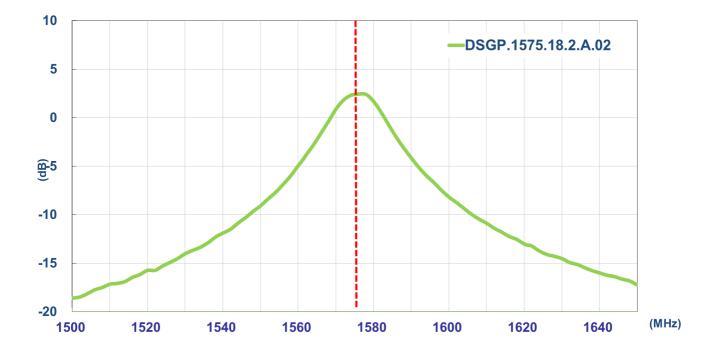
3.







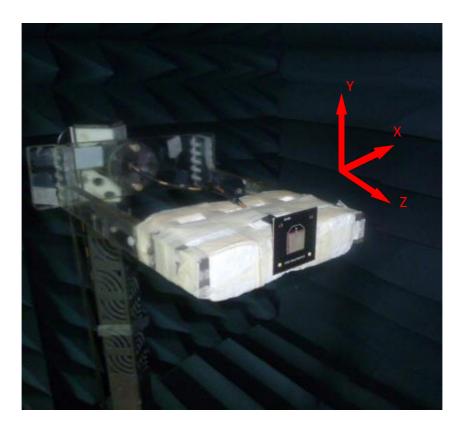
Peak Gain









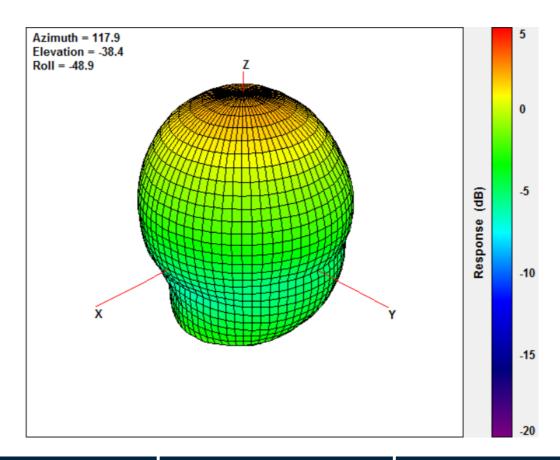


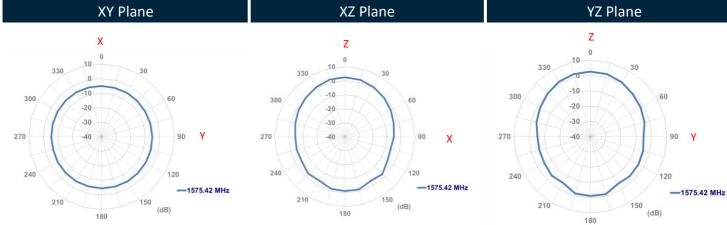
On Evaluation Board

Taoglas Part number: DSGPD.18B

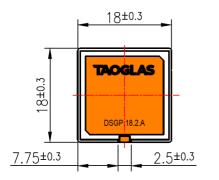


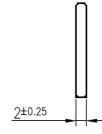
### 4.2 1575.42MHz 3D and 2D Radiation Patterns

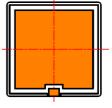










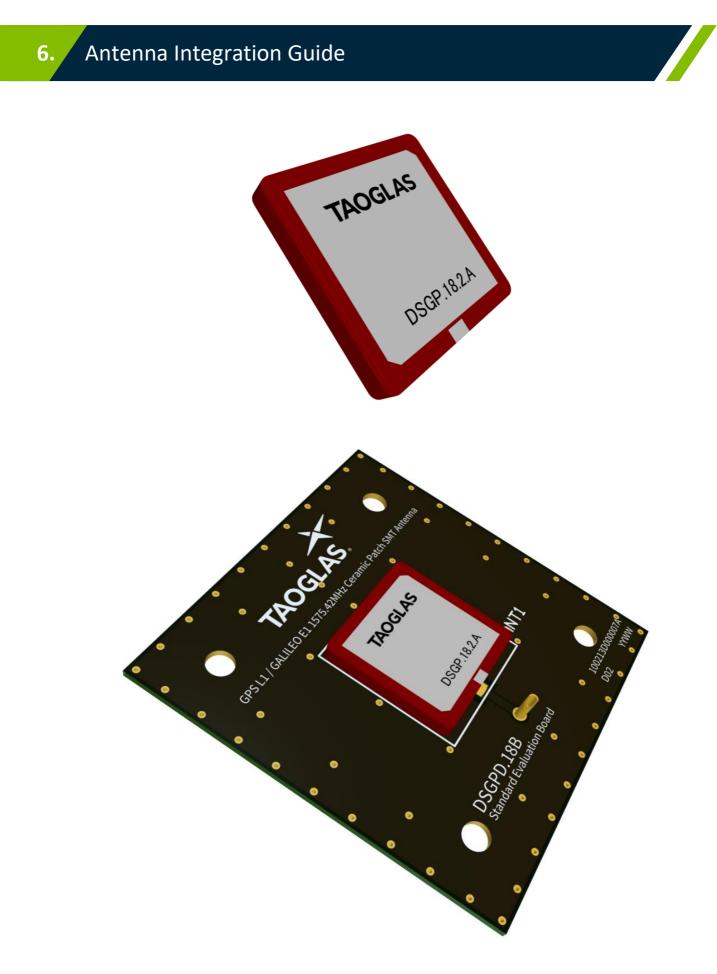


Top View

Side View

**Bottom View** 



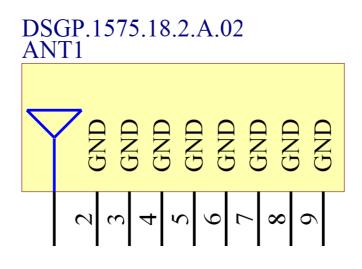




### 6.1 Schematic Symbol and Pin Definition

The circuit symbol for the antenna is shown below. The antenna has 8 pins with all as functional.

| Pin                 | Description |
|---------------------|-------------|
| 1                   | RF Feed     |
| 2, 3, 4, 5, 6, 7, 8 | Ground      |



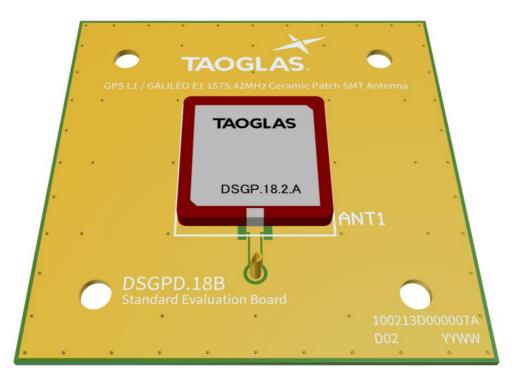


#### 6.2 Antenna Integration

The antenna should be placed at the center of the ground plane with a length and width of 50mm. Maintaining a square symmetric ground plane shape and symmetric environment around the antenna is critical to maintaining the excellent axial ratio and phase center performance shown in this datasheet.



Top Side w/ Solder Mask



Top Side w/o Solder Mask

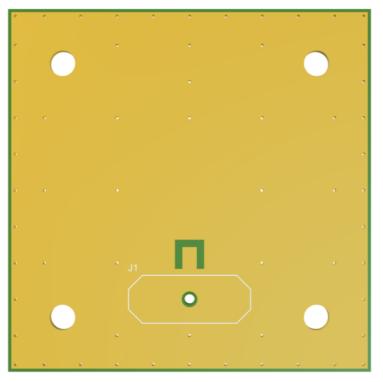


### 6.3 PCB Layout

The footprint and clearance on the PCB must comply with the antenna specification. The PCB layout shown in the diagram below demonstrates the antenna footprint.



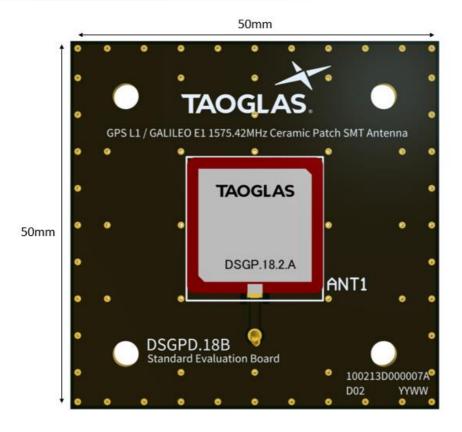
Topside



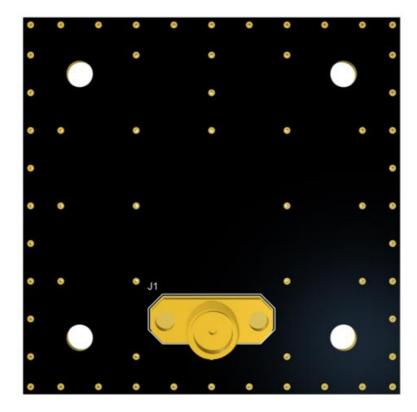
Bottom Side



## 6.4 Evaluation Board



#### Topside

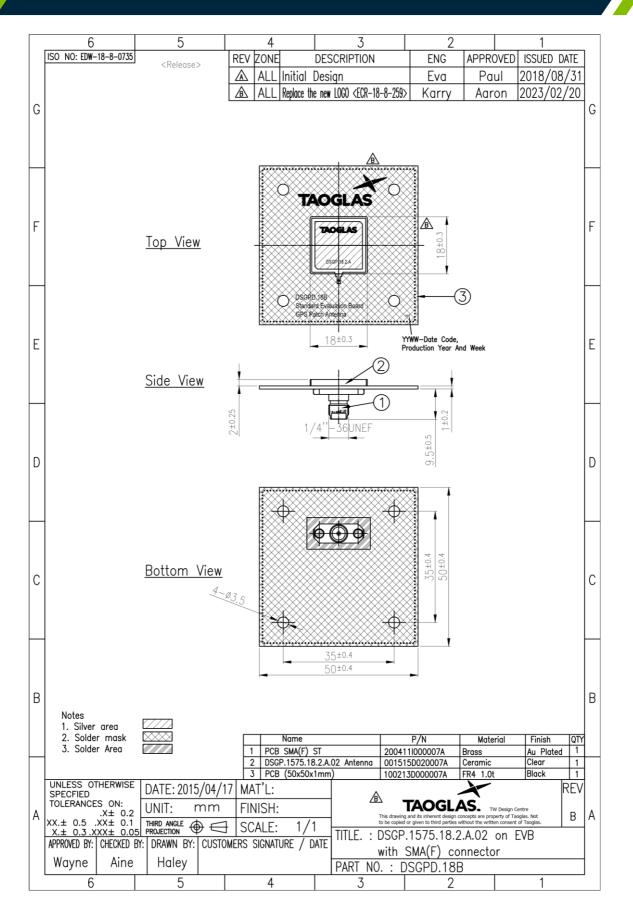


**Bottom Side** 



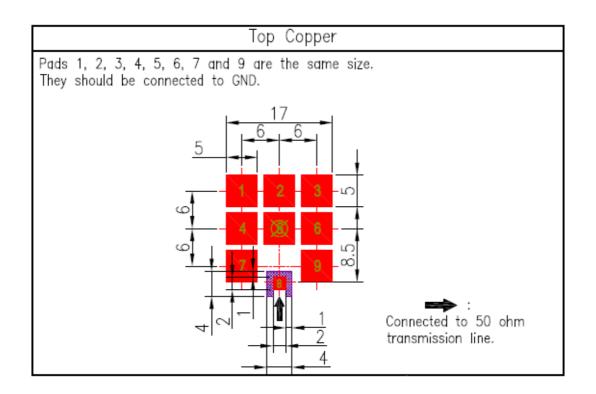
## Evaluation Board Mechanical Drawing

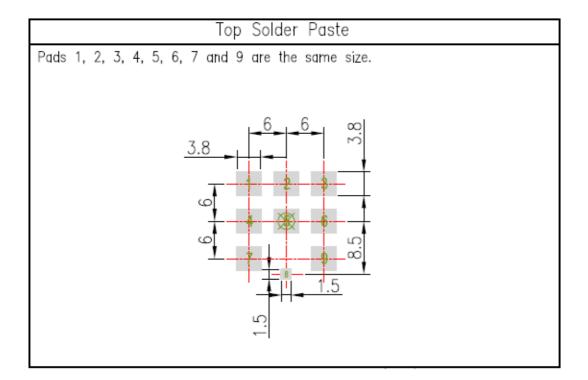
7.





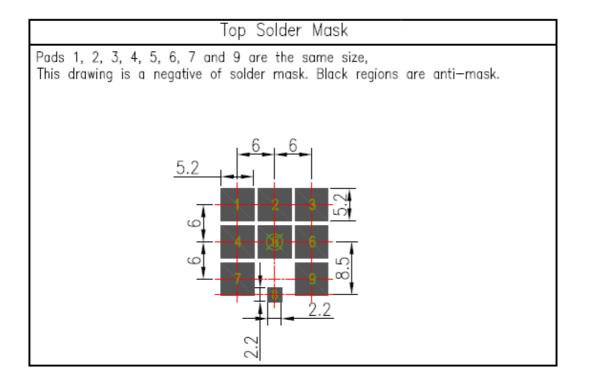
## PCB Footprint Recommendation

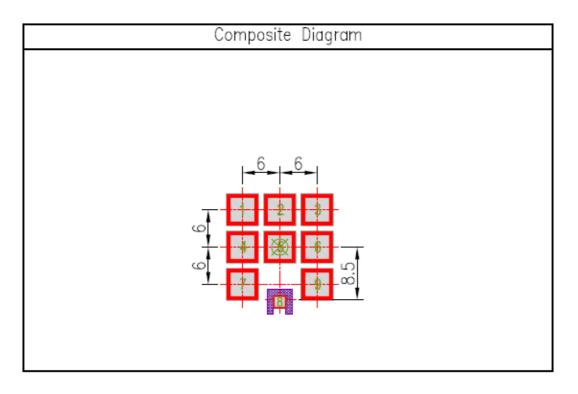




8.







NOTE:

- Ag Plated area
  Solder Mask area
  Copper area



- 4. Paste area
- 5. Copper Keepout Area
- 6. Copper keepout should extend through all PCB layers.

7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.

8. The dimension tolerances should follow standard PCB manufacturing guidelines

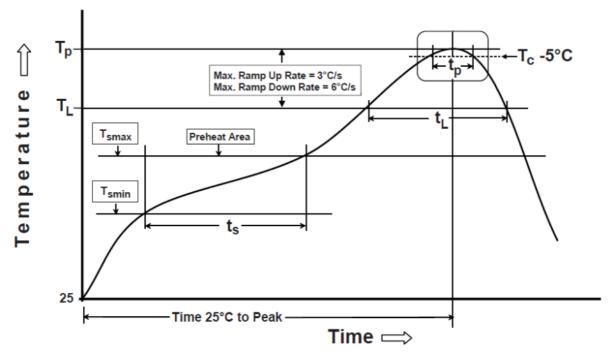


9.

DSGP.1575.18 can be assembled following Pb-free assembly. According to the Standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follows:

| Phase     | Profile Features                   | Pb-Free Assembly (SnAgCu) |
|-----------|------------------------------------|---------------------------|
|           | Temperature Min (Tsmin)            | 150°C                     |
| PREHEAT   | Temperature Max (Tsmax)            | 200°C                     |
|           | Time(ts) from (Tsmin to Tsmax)     | 60-120 seconds            |
| RAMP-UP   | Avg. Ramp-up Rate (Tsmax to TP)    | 3°C/second(max)           |
|           | Temperature (TL)                   | 217°C                     |
| REFLOW    | Total Time above TL (tL)           | 30-100 seconds            |
| PEAK      | Temperature (TP)                   | 260°C                     |
|           | Time(tp)                           | 2-5 seconds               |
| RAMP-DOWN | Rate                               | 3°C/second(max)           |
|           | Time from 25°C to Peak Temperature | 8 minutes max.            |
|           | Composition of solder paste        | 96.5Sn/3Ag/0.5Cu          |
|           | Solder Paste Model                 | SHENMAO PF606-P26         |

The graphic shows temperature profile for component assembly process in reflow ovens



Soldering Iron condition : Soldering iron temperature 270°C±10°C.

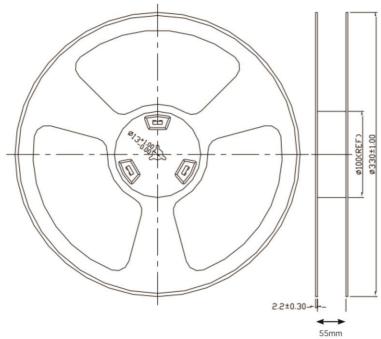
Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron temperature over270°C±10°C or 3 seconds, it will make cause component surface peeling or damage.

SPE-17-8-029-D

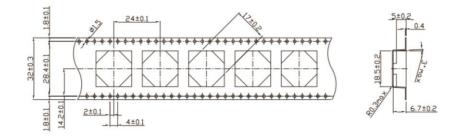


## 10. Packaging

200 pc DSGP.1575.18.2.A.02 per reel Dimensions - Ø330\*55mm Weight - 800g



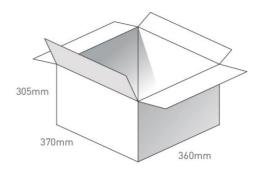






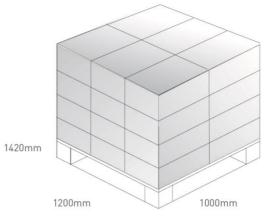
350 mm

1 pc reel in small in Anti-static Bag Dimensions - 340\*350\*70mm Weight - 1.2Kg



340mm

4 Reels i n Anti-static Bags 800 pcs in one carton Carton Dimensions - 370\*360\*305mm Weight - 5.6Kg



Pallet Dimensions 1200\*1000\*1420mm 24 Cartons per Pallet 6 Cartons per layer 4 Layers



Changelog for the datasheet

#### SPE-17-8-029 - DSGP.1575.18.2.A.02

| Revision: C (Current | Version)                        |
|----------------------|---------------------------------|
| Date:                | 2023-02-27                      |
| Changes:             | Antenna Integration Guide Added |
| Changes Made by:     | Cesar Sousa                     |
|                      |                                 |

#### **Previous Revisions**

| Revision: C      |  |
|------------------|--|
| Date:            | 2021-09-07   |
| Changes:         | Fixed Alignment of radiation patterns section.<br>Added MSL rating.<br>Fixed Font in tables. |
| Changes Made by: | Erik Landi   |

| Revision: B      |                 |
|------------------|-----------------|
| Date:            | 2019-09-17      |
| Changes:         | Updated Drawing |
| Changes Made by: | Jack Conroy     |

| Revision: A (Original First Release) |             |  |
|--------------------------------------|-------------|--|
| Date:                                | 2017-05-22  |  |
| Notes:                               |             |  |
| Author:                              | Jack Conroy |  |



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